



**Micro Commercial Components** 

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# BC846A THRU BC848C

### **Features**

• Power Dissipation: 0.225W (T<sub>amb</sub>=25℃)(Note 1)

Collector Current: 0.1A

## **Maximum Ratings**

Operating temperature : -55°C to +150°C
Storage temperature : -55°C to +150°C

#### **DEVICE MARKING**

Symbol

BC846A=1A,46A; BC846B=1B,46B;

BC847A=1E,47A; BC847B=1F,47B; BC847C=1G,47C; BC848A=1J,48A; BC848B=1K,48B: BC848C=1L,48C

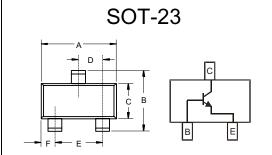
Parameter

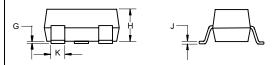
#### Electrical Characteristics @ 25% Unless Otherwise Specified

OFF CHARA	CTERISTICS			
$V_{(BR)CBO}$	Collector-Base Breakdown Voltage (I <sub>C</sub> =10µAdc, I <sub>E</sub> =0)			Vdc
	BC846		80	
	BC847		50	
	BC848		30	
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage (I <sub>C</sub> =10mAdc, I <sub>B</sub> =0)			Vdc
	BC846		65	
	BC847		45	
	BC848		30	
$V_{(BR)EBO}$	Collector-Emitter Breakdown Voltage (I <sub>E</sub> =10µAdc, I <sub>C</sub> =0)		6	Vdc
I <sub>CBO</sub>	Collector Cut-off Current		0.1	μAdc
	BC846 ( $V_{CB}$ =80V, $I_{E}$ =0) BC847 ( $V_{CB}$ =50V, $I_{E}$ =0) BC848 ( $V_{CB}$ =30V, $I_{E}$ =0)			
I <sub>CEO</sub>	Collector Cut-off Current		0.1	µAdc
ICEO	BC846 (V <sub>CE</sub> =60V, I <sub>B</sub> =0) BC847 (V <sub>CE</sub> =45V, I <sub>B</sub> =0) BC848 (V <sub>CE</sub> =30V, I <sub>B</sub> =0)		0.1	μλασ
I <sub>EBO</sub>	Emitter Cut-off Current		0.1	μAdc
·EBO	$(V_{EB}=5V, I_{C}=0mA)$		0.1	μπασ
H <sub>FE(1)</sub>	DC Current Gain(V <sub>CE</sub> =5V, I <sub>C</sub> =2mA) BC846A, 847A, 848A	110	220	
	BC846B, 847B, 848B	200	450	
	BC847C, BC848C	420	800	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage (I <sub>C</sub> =100mA, I <sub>B</sub> =5mA)		0.5	Vdc
V <sub>BE(sat)</sub>	Base-Emitter Saturation Voltage (I <sub>C</sub> =100mA, I <sub>B</sub> =5mA)		1.1	Vdc
f⊤	Transition Frequency (V <sub>CE</sub> =5V, I <sub>C</sub> =10mA, f=100MHz)	100		MHz

#### Note 1: Transistor mounted on an FR4 printed-circuit board

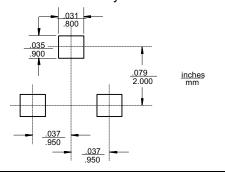
# NPN Plastic-Encapsulate Transistors





DIMENSIONS								
	INCHES		MM					
DIM	MIN	MAX	MIN	MAX	NOTE			
Α	.110	.120	2.80	3.04				
В	.083	.098	2.10	2.64				
С	.047	.055	1.20	1.40				
D	.035	.041	.89	1.03				
E	.070	.081	1.78	2.05				
F	.018	.024	.45	.60				
G	.0005	.0039	.013	.100				
Н	.035	.044	.89	1.12				
J	.003	.007	.085	.180				
K	.015	.020	.37	.51				

#### Suggested Solder Pad Layout







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